



FORM PTO-1449 (MODIFIED)		ATTORNEY DOCKET NO.	SERIAL NO.
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT		SP01-300A	10/255,777
		APPLICANT Filhaber et al.	
		FILING DATE September 25, 2002	GROUP: 2874

REFERENCE DESIGNATION		U.S. PATENT DOCUMENTS			
Examiner Initial	Document Number	Date	Name	Class	Sub-Class
AA					
AB					
AC					
AD					
AE					
AF					
AG					
AH					
AI					
AJ					
AK					

FOREIGN PATENT DOCUMENTS					
	Document Number	Date	Country	Class	Sub-Class
AL					
AM					
AN					
AO					
AP					
AQ					

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

MH	AR	Andreas Piohl et al., Wafer Direct Bonding: Tailoring Adhesion Between Brittle Materials, Materials Science and Engineering, R25 (1999) pp. 1-88.
	AS	
	AT	
	AU	
	AV	
	AW	

EXAMINER: <i>M. Halpern</i>	DATE CONSIDERED: <i>12/8/03</i>
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	